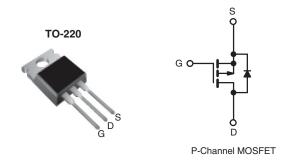


COMPLIANT

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	- 60	- 60				
$R_{DS(on)}\left(\Omega\right)$	V _{GS} = - 10 V	0.28				
Q _g (Max.) (nC)	19)				
Q _{gs} (nC)	5.4	1				
Q _{gd} (nC)	11	11				
Configuration	Sing	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- · Simple Drive Requirements
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRF9Z24PbF
Lead (PD)-liee	SiHF9Z24-E3
SnPb	IRF9Z24
SILD	SiHF9Z24

ABSOLUTE MAXIMUM RATINGS T	_C = 25 °C, ur	nless otherw	ise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	- 60	V	
Gate-Source Voltage			V_{GS}	± 20	V	
Continuous Drain Current	V = 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		- 11		
	V _{GS} at - 10 V	T _C = 100 °C	I _D	- 7.7	Α	
Pulsed Drain Current ^a			I _{DM}	- 44	1	
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	240	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 11	А	
Repetitive Avalanche Energy ^a			E _{AR}	6.0	mJ	
Maximum Power Dissipation	T _C = 2	25 °C	P_{D}	60	W	
Peak Diode Recovery dV/dtc			dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	1	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 2.3 mH, R_G = 25 Ω , I_{AS} = 11 A (see fig. 12).
- c. $I_{SD} \le$ 11 A, $dI/dt \le$ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le$ 175 °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5	

SPECIFICATIONS T _J = 25 °C,	unless otherv	vise noted					
PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static					•		,
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA		- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = - 1 mA	-	- 0.056	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	' _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	V	_{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	1	V _{DS} = - 60 V, V _{GS} = 0 V		-	-	- 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 48 V,	V _{GS} = 0 V, T _J = 150 °C	-	-	- 500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 6.6 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} = - 2	25 V, I _D = - 6.6 A ^b	1.4	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	570	-	
Output Capacitance	C _{oss}			-	360	-	pF
Reverse Transfer Capacitance	C _{rss}			-	65	-	1
Total Gate Charge	Q_g			-	-	19	
Gate-Source Charge	Q_{gs}	V _{GS} = - 10 V	I _D = - 11 A, V _{DS} = - 48 V, see fig. 6 and 13 ^b	-	-	5.4	nC
Gate-Drain Charge	Q_{gd}]		-	-	11	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = \text{-} 30 \text{ V, } I_D = \text{-} 11 \text{ A,}$ $R_G = 18 \Omega, \ R_D = 2.5 \Omega, \text{ see fig. } 10^b$		-	13	-	- ns
Rise Time	t _r			-	68	-	
Turn-Off Delay Time	t _{d(off)}			-	15	-	
Fall Time	t _f			-	29	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L _S			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s				•		,
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 11	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 44	
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = - 11 A, V _{GS} = 0 V ^b		-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = - 11 A, dl/dt = 100 A/μs ^b		-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.32	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

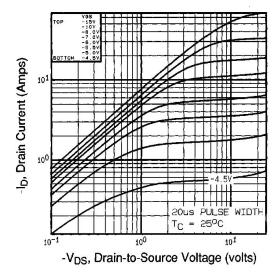


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

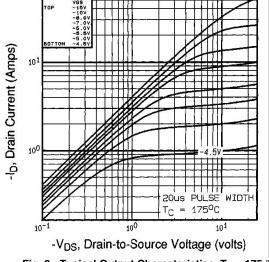


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

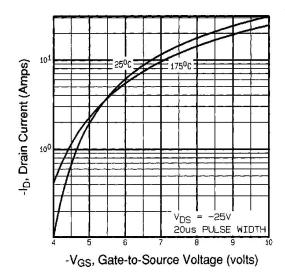


Fig. 3 - Typical Transfer Characteristics

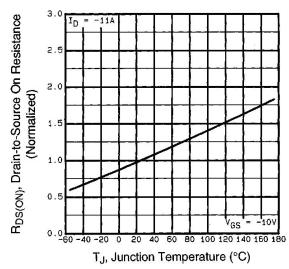


Fig. 4 - Normalized On-Resistance vs. Temperature



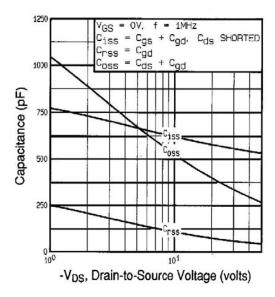


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

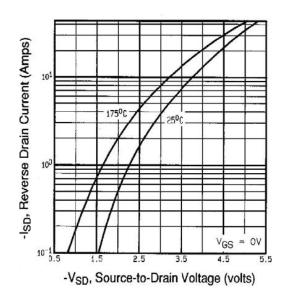


Fig. 7 - Typical Source-Drain Diode Forward Voltage

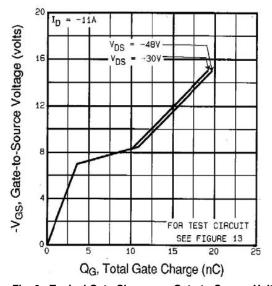


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

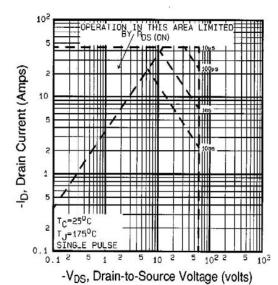


Fig. 8 - Maximum Safe Operating Area





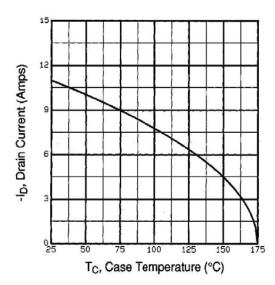


Fig. 9 - Maximum Drain Current vs. Case Temperature

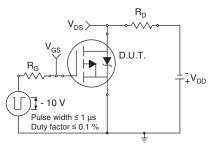


Fig. 10a - Switching Time Test Circuit

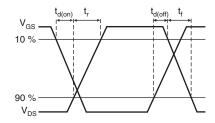


Fig. 10b - Switching Time Waveforms

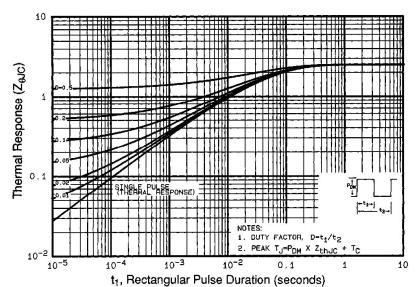


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

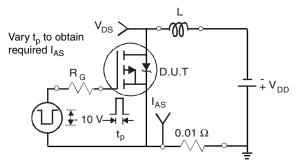


Fig. 12a - Unclamped Inductive Test Circuit

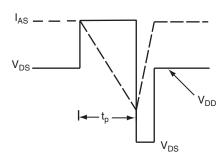


Fig. 12b - Unclamped Inductive Waveforms



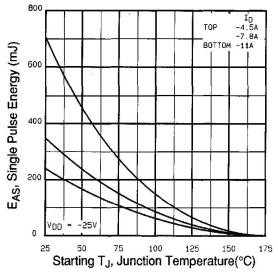


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

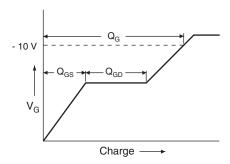


Fig. 13a - Basic Gate Charge Waveform

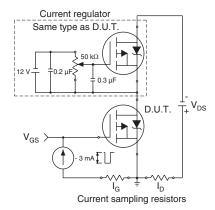
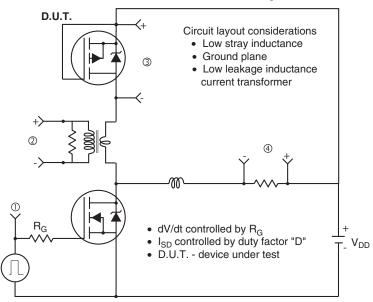


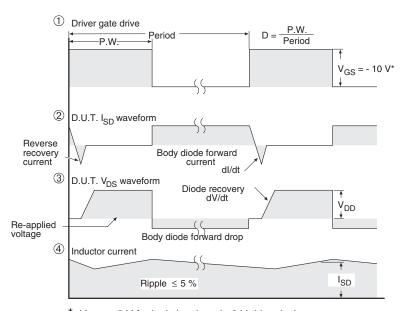
Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



* V_{GS} = - 5 V for logic level and - 3 V drive devices

Fig. 14 - For P-Channel

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